g		GE Energy	,	Functional T	esting Spe	cification	
Parts & Repair Services Louisville, KY				LOU-GED-872D421G1			
		Test Proced	dure for a 3KHz o	oscillator.			
DOCU	MENT REVISION STATUS	: Determined by the last e	ntry in the "REV" ar	d "DATE" column			
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	ARED BY Chibald	REVIEWED BY	REVIEWE	D BY	Charlie War		
<b>DATE</b> 6/25/2	2014	DATE	DATE		<b>DATE</b> 6/25/2014		

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REV. A	Parts & Repair Services	
	Louisville, KY	

#### 1. SCOPE

**1.1** This is a functional testing procedure for a Card.

## 2. STANDARDS OF QUALITY

**2.1** Refer to the current revision of the IPC-A-610 standard for workmanship standards.

# 3. APPLICABLE DOCUMENTS

- **3.1** The following document(s) shall form part of this specification to the extent specified herein. Unless otherwise indicated, the latest issue shall apply.
  - **3.1.1** Check board's electronic folder for more information

## 4. **ENGINEERING REQUIREMENTS**

- 4.1 Equipment Cleaning
  - **4.1.1** Equipment should be clean and free of debris prior to applying power unless performing an initial check. Refer to site specific SRA's for cleaning guidelines.
- **4.2** Equipment Inspection
  - **4.2.1** Equipment should be visually inspected for any defects prior to applying power. This inspection should include the following as a minimum:
    - 4.2.1.1 Wires broken, cracked, or loosely connected
    - 4.2.1.2 Terminal strips / connectors broken or cracked
    - 4.2.1.3 Components visually damaged
    - **4.2.1.4** Capacitors bloated or leaking
    - 4.2.1.5 Solder joints damaged or cold
    - 4.2.1.6 Circuit board burned or de-laminated
    - 4.2.1.7 Printed wire runs / Traces burned or damaged

#### 5. EQUIPMENT REQUIRED

**5.1** The following equipment is required to perform the process requirements. Equipment may be substituted provided that all accuracy's and test ratios are equivalent or better.

Qty	Reference #	Description
1		Fluke 87 DMM (or Equivalent)
1		10VDC Adjustable Power Supply
1		Scope
1		220 ohm
1		4.7K ohm

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## 6. Testing Process

- 6.1 Setup
  - **6.1.1** Setup per drawing in section 7.

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- 6.2 Testing Procedure
  - **6.2.1** Set R11 and R7 to mid-range.
  - 6.2.2 Adjust PS1 for 8V peak-peak at pin-9. Should occur at 8.8VDC +/- 0.5V.
  - **6.2.3** Check frequency of square wave at pin-9. Should be between 3030 and 3150Hz.
  - **6.2.4** Turn card on and off  $\frac{1}{2}$  dozen times to make sure unit runs consistently.
- 6.3 Post Testing Burn-in

Required \_X\_ Yes \_\_\_ No

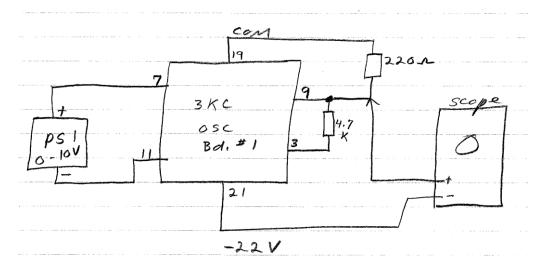
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**Note:** All MARK I, II, & III Turbine related cards require a post testing burn-in of 100 hours.

- **6.3.1** Apply BUS or Operational power to the card for a period of 100 hours.
- **6.3.2** Re-test card while warm using the above procedure.
- 6.4 \*\*\*TEST COMPLETE \*\*\*

#### 7. <u>Note</u>

7.1 Setup drawing.



# 8. Attachments

**8.1** None at this time.